

Prof BS Saini

From: "Placement Punjabi University" <placement@pbi.ac.in>
Date: Saturday, July 22, 2017 12:34 PM
To: <placement.brs@gmail.com>
Cc: "Deepak Kumar" <erdeepak61@gmail.com>
Attach: Data Format 2017 Batch.xls
Subject: Fwd: Invitation to a joint Campus Placement Drive by Broadcom Limited at CGC Landran

Dr Balraj - pl post for B.Tech (CSE, ECE) with 60% throughout- interested students to send details, as per the attached Format, to placement@pbi.ac.in by 23rd July.

Dr Dham

Sent from my iPhone

Begin forwarded message:

From: "CRC (CGC Landran)" <crc@cgc.edu.in>
Date: 22 July 2017 at 12:24:22 PM IST
To: "Mr. Avnish K. Rao" <avnish.crc@cgc.edu.in>
Subject: Invitation to a joint Campus Placement Drive by Broadcom Limited at CGC Landran

Dear Sir/Madam,

Chandigarh Group of Colleges, Landran takes this opportunity to invite students from your institute to participate in the joint campus placement drive **Broadcom Limited** for **B.Tech (CS, IT, ECE, EEE)** students of 2017 passing out batch. The details are as follows.

About the Company

Broadcom Limited is one of the world's largest fabless semiconductor companies, with 2014 revenue of \$8.43 billion, has more than 20,000 U.S. and foreign patents and applications, and one of the broadest intellectual property portfolios addressing both wired and wireless transmission of voice, video, data and multimedia. Broadcom is headquartered in Irvine, Calif., and has offices and research facilities in North America, Asia and Europe. Broadcom Communication India is one of biggest offshore research and development center of Broadcom outside US. (www.broadcom.com)

Name of the Company	Broadcom Limited
Date of Drive	3rd August 2017
Venue	Will be intimated later
Stream Required	B.Tech (CS, IT, ECE, EEE)
Eligibility Criteria	60 % throughout
Batch	2017
Position	Wireless Test Engineer
Job Profile	Broadcom Limited India's Wireless Connectivity Combos (WCC) business unit works on delivering world class Wireless LAN and BT solutions to our customers. Broadcom's WCC System and Design verification team specializes in providing test and automation solutions to WLAN and BT ICs. The work involves learning fundamentals of networking, protocols(WLAN and BT) and developing test automation and programming skills. Broadcom is a world leader in providing WLAN combo solutions. Our WLAN coexistence team works on challenging technologies to deliver WLAN solutions coexists with other wireless technologies like Bluetooth. Above mentioned group is

	looking out for talented engineers to deliver on challenges that we have in Broadcom.
Job Location	Bangalore
Pay Package	4 LPA from Day one
Placement Process	Aptitude written test (Pen & Paper) followed by multiple round of interviews

TPOs are requested to inform all the students of **2017** passing out batch accordingly and forward the list of participating students (**as per attached format**) at crc@cgc.edu.in latest by **21st July 2017 before 1:00 pm** positively.

For queries please feel free to contact us at: **9781925274, 0172-3984241.**

Thanks and Regards

Avnish K. Rao

Asstt. Manager-Placement

Chandigarh Group of Colleges

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